

# InGaAs PIN Module

## Features

Active diameter 300um

Small dark current

High reliability

## Applications

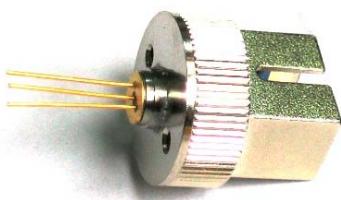
Fiberoptics telecommunication networks

Digital receivers

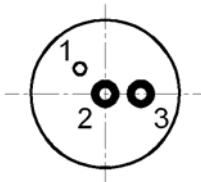
Optical interconnects

Test and measurement

Datacom



## PIN assignment



pin	Function
1(case)	GND
2	N
3	P

This device is susceptible to damage as a result of electrostatic discharge (ESD). A static free environment is highly recommended. Follow guidelines according to proper ESD procedures



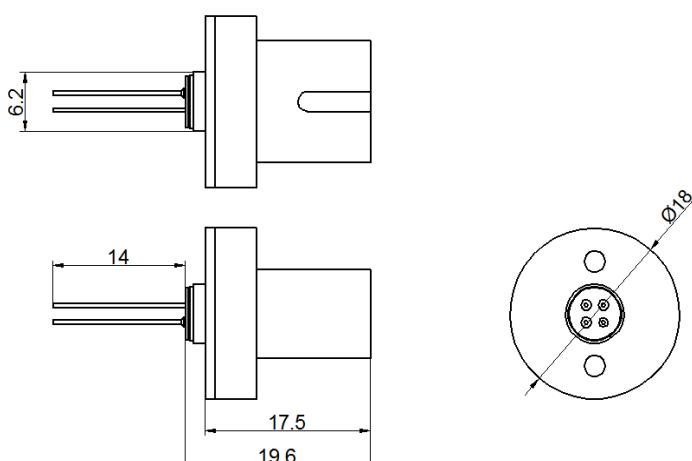
## Absolute maximum ratings

Parameter	Symbol	Value	Unit
Storage temperature	Tst	-40~+85	°C
Operating temperature	Top	-40~+85	°C
Reverse voltage	V <sub>R</sub>	30	V
Soldering temperature/time	—	260/10	°C/s

## Optical & electrical characteristics(T=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Detection range	λ	1100	-	1650	nm	-
Dark current	I <sub>d</sub>	-	0.1	1	nA	V <sub>R</sub> =5V
Quantum efficiency	R	0.80	0.85	-	A/W	V <sub>R</sub> =5V, λ=1310 nm
Capacitance	C <sub>t</sub>	-	-	0.75	pF	V <sub>R</sub> =5V

## Dimensions Diagram



## Order information

D	1	03	X	B
			Range 0,-70~+6dBm 1, -60~+10dBm 2, -50~+20dBm	Package S,S